Glass Passivated Bridge Rectifiers

Reverse Voltage - 800 Volts Forward Current - 20 Amperes

Features

- Glass passivated chip
- Low forward voltage drop
- Ideal for printed circuit board
- High surge current capability

Mechanical Data

- Polarity: Symbol marked on body
- Mounting position: Any

Note: Products with logo or or or are made by HY Electronic (Cayman) Limited.

Applications

 General purpose use in AC/DC bridge full wave rectification, for SMPS, lighting ballaster, adapter, etc.

.165 (4.2) *45° (3.8 X5.7L) Hole Thru .895 (22.7) .700 (17.8) .600 (16.8) .780 (19.8) .740 (18.8)

Package Outline Dimensions in Inches (Millimeters)

.220 (5.6) .180 (4.6)

.276 (7.0)

Maximum Ratings and Electrical Characteristics

Rating at 25°C ambient temperature unless otherwise specified.

Single phase, half wave, 60Hz, resistive or inductive load.

For capacitive load, derate current by 20%.

Characteristics	Symbol	KBU2508G	Unit
Maximum Repetitive Peak Reverse Voltage	Vrrm	800	V
Maximum RMS Voltage	VRMS	560	V
Maximum DC Blocking Voltage	VDC	800	V
Maximum Average Forward (with heatsink Note 1) Rectified Current @ Tc=100℃	l(AV)	20	А
Peak Forward Surge Current, 8.3mS Single Half Sine-Wave, Superimposed on Rated Load (JEDEC Method)	IFSM	280	А
I ² t Rating for Fusing (t<8.3mS)	l ² t	325.4	A ² s
Peak Forward Voltage per Diode at 10A DC	VF	1.1	V
Maximum DC Reverse Current at Rated @TJ=25°C	lr	10	
DC Blocking Voltage per Diode $@T_J=125^{\circ}\!\mathbb{C}$		500	μΑ
Operating Junction Temperature Range	TJ	-55 to +150	°C
Storage Temperature Range	Тѕтс	-55 to +150	$^{\circ}$

.087 (2.2)

.071 (1.8)



Fig. 1 - Forward Current Derating Curve

25

20

(V) 110

15

0

0

50

100

150

Case Temperature (°C)

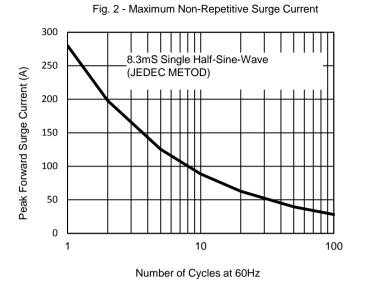
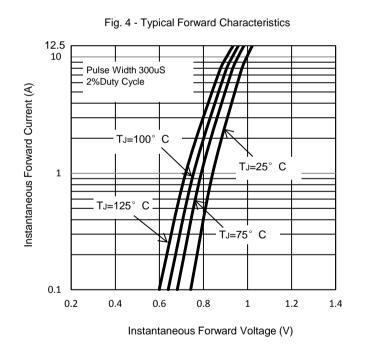


Fig. 3 - Typical Reverse Characteristics 1000 T_J=150° C Instantaneous Reverse Current (uA) 100 $T_{J}=125^{\circ} C$ 10 TJ=100° C TJ=75° C 1 T_J=25° C 0.1 20 40 60 80 100 Percent of Rated Peak Reverse Voltage (%)





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